

### General Description

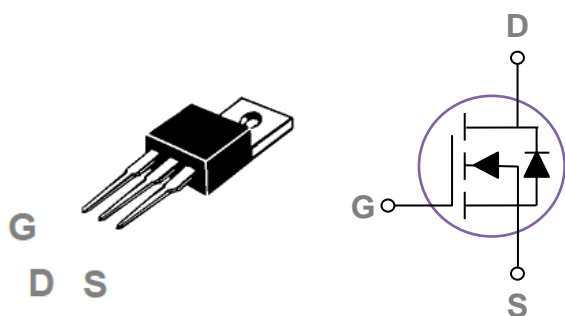
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
100V	4.1mΩ	135A

### Features

- 100V, 135A,  $R_{DS(ON)} = 4.1\text{m}\Omega @ V_{GS} = 10\text{V}$
- Improved  $dv/dt$  capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### TO220 Pin Configuration



### Applications

- Networking
- Load Switch
- LED applications
- Quick Charger

### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	100	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_c=25^\circ\text{C}$ )	135	A
	Drain Current – Continuous ( $T_c=100^\circ\text{C}$ )	85	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	540	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	405	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	90	A
$P_D$	Power Dissipation ( $T_c=25^\circ\text{C}$ )	240	W
	Power Dissipation – Derate above $25^\circ\text{C}$	1.92	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-55 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction to Case	---	0.52	$^\circ\text{C}/\text{W}$

**Electrical Characteristics ( $T_J=25\text{ }^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	100	---	---	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=80V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=80V, V_{GS}=0V, T_J=85^\circ\text{C}$	---	---	10	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{DS(ON)}$	Static Drain-Source On-Resistance <sup>3, 4</sup>	$V_{GS}=10V, I_D=20A$	---	3.4	4.1	m $\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	2	2.6	4	V
gfs	Forward Transconductance	$V_{DS}=10V, I_D=3A$	---	18	---	S

**Dynamic and switching Characteristics**

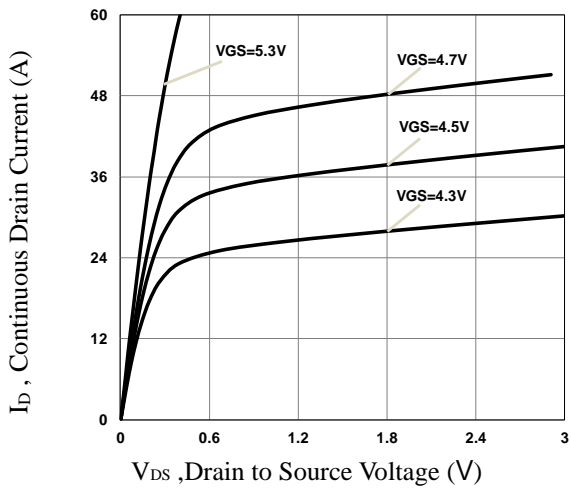
$Q_g$	Total Gate Charge <sup>3, 4</sup>	$V_{DS}=50V, V_{GS}=10V, I_D=70A$	---	56	85	nC
$Q_{gs}$	Gate-Source Charge <sup>3, 4</sup>		---	13.5	20	
$Q_{gd}$	Gate-Drain Charge <sup>3, 4</sup>		---	15	25	
$T_{d(on)}$	Turn-On Delay Time <sup>3, 4</sup>	$V_{DD}=50V, V_{GS}=10V, R_G=6\Omega, I_D=70A$	---	24	36	ns
$T_r$	Rise Time <sup>3, 4</sup>		---	20	30	
$T_{d(off)}$	Turn-Off Delay Time <sup>3, 4</sup>		---	45	70	
$T_f$	Fall Time <sup>3, 4</sup>		---	25	40	
$C_{iss}$	Input Capacitance	$V_{DS}=50V, V_{GS}=0V, F=1\text{MHz}$	---	3750	5650	pF
$C_{oss}$	Output Capacitance		---	750	1150	
$C_{rss}$	Reverse Transfer Capacitance		---	10	15	
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	1.8	---	$\Omega$

**Drain-Source Diode Characteristics and Maximum Ratings**

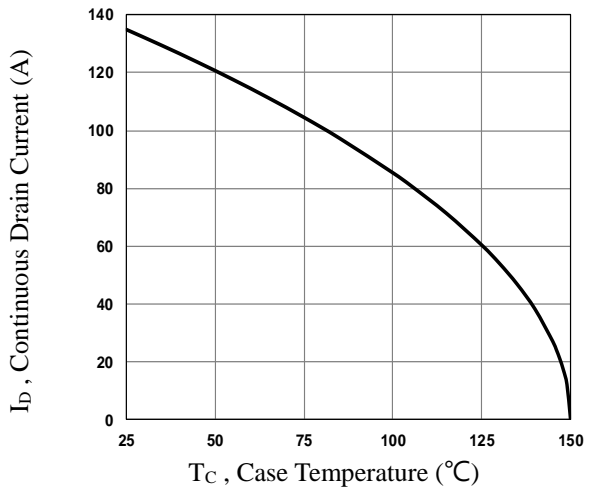
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	135	A
$I_{SM}$	Pulsed Source Current		---	---	270	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1	V
$t_{rr}$	Reverse Recovery Time	$V_R=100V, I_S=10A$	---	210	---	ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=100A/\mu s, T_J=25^\circ\text{C}$	---	510	---	nC

Note :

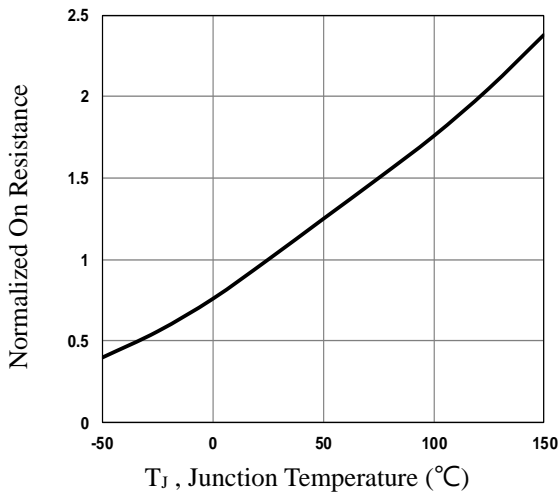
1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=50V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=90A, R_G=25\Omega, \text{Starting } T_J=25^\circ\text{C}$ .
3. The data tested by pulsed , pulse width  $\leq 300\mu s$  , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.



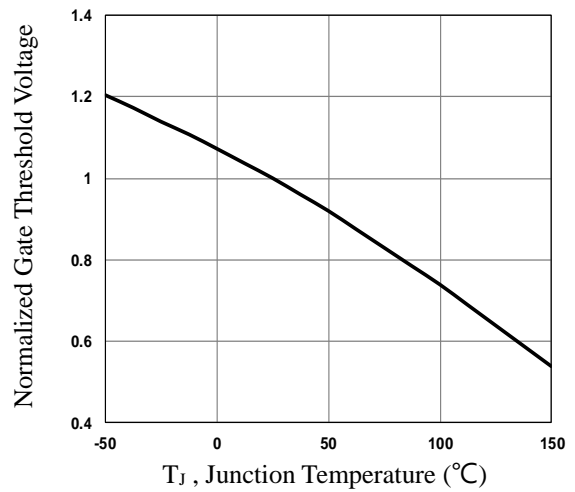
**Fig.1 Typical Output Characteristics**



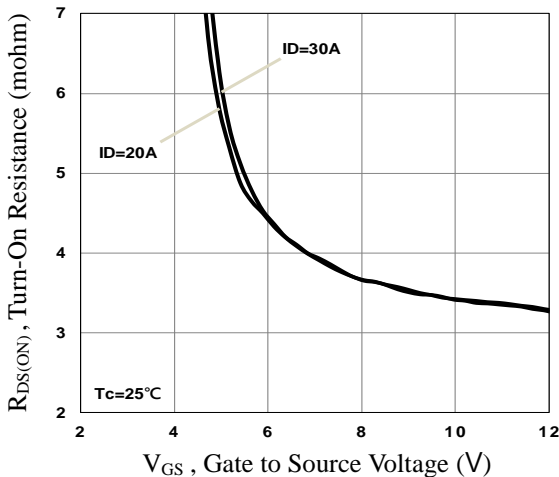
**Fig.2 Continuous Drain Current vs.  $T_C$**



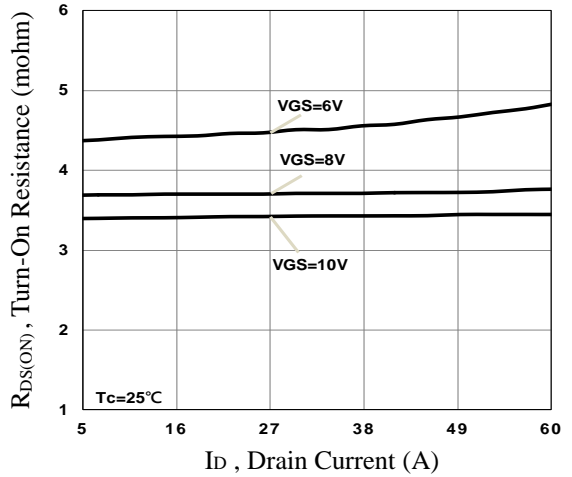
**Fig.3 Normalized  $R_{DS(on)}$  vs.  $T_J$**



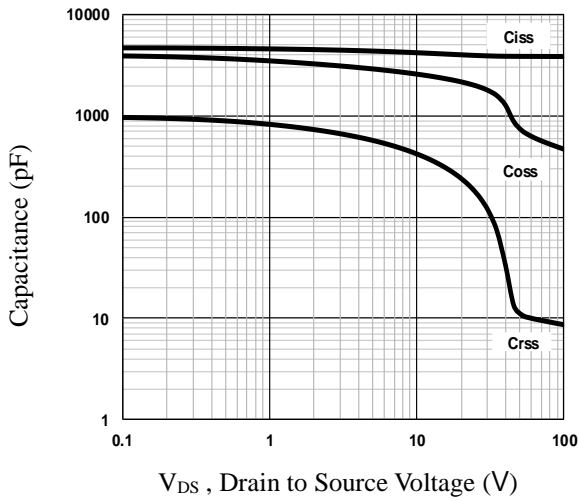
**Fig.4 Normalized  $V_{th}$  vs.  $T_J$**



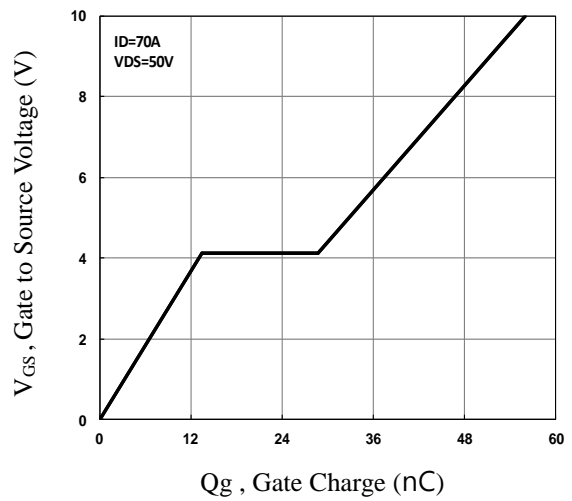
**Fig.5 Turn-On Resistance vs.  $V_{GS}$**



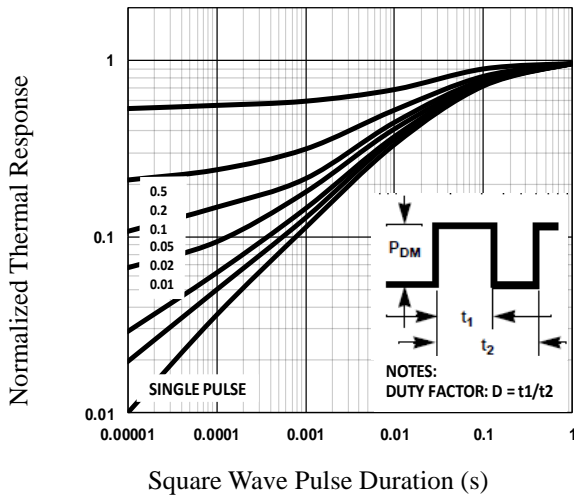
**Fig.6 Turn-On Resistance vs.  $I_D$**



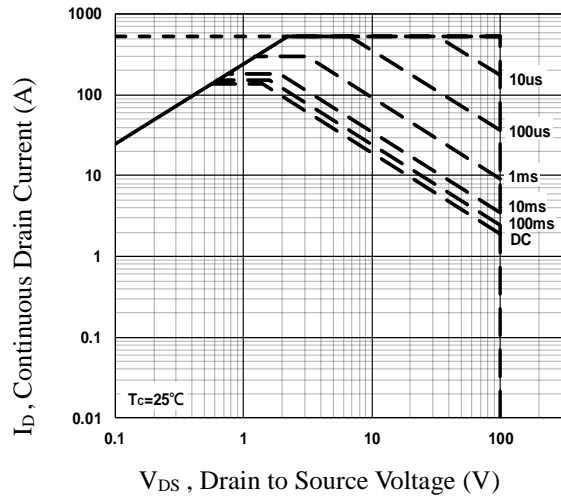
**Fig.7 Capacitance Characteristics**



**Fig.8 Gate Charge Characteristics**

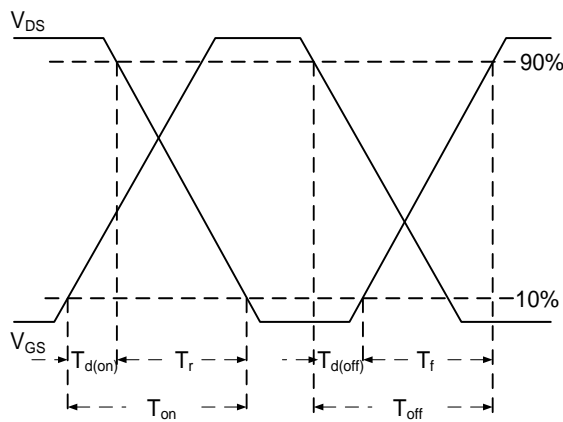


**Fig.9 Normalized Transient Impedance**

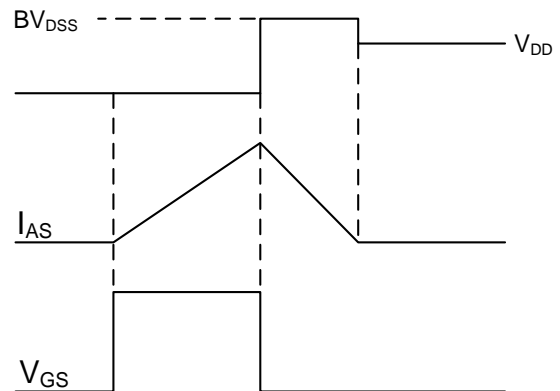


**Fig.10 Maximum Safe Operation Area**

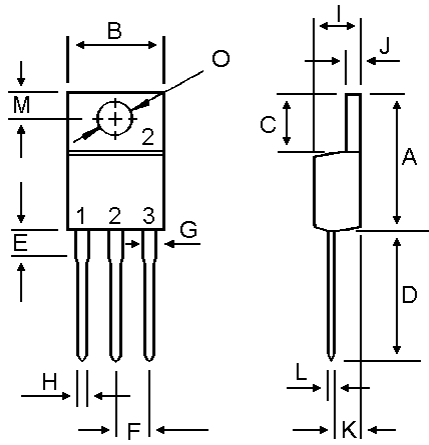
$$EAS = \frac{1}{2} L \times I_{AS}^2 \times \frac{BV_{DSS}}{BV_{DSS} - V_{DD}}$$



**Fig.11 Switching Time Waveform**



**Fig.12 EAS Waveform**



DIM	MILLIMETERS	
	MIN	MAX
A	14.68	16.00
B	9.78	10.42
C	5.02	6.60
D	13.00	14.62
E	3.10	4.19
F	2.41	2.67
G	1.10	1.67
H	0.69	1.01
I	4.22	4.98
J	1.14	1.40
K	2.20	3.30
L	0.28	0.61
M	2.48	3.00
O	3.50	4.00

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